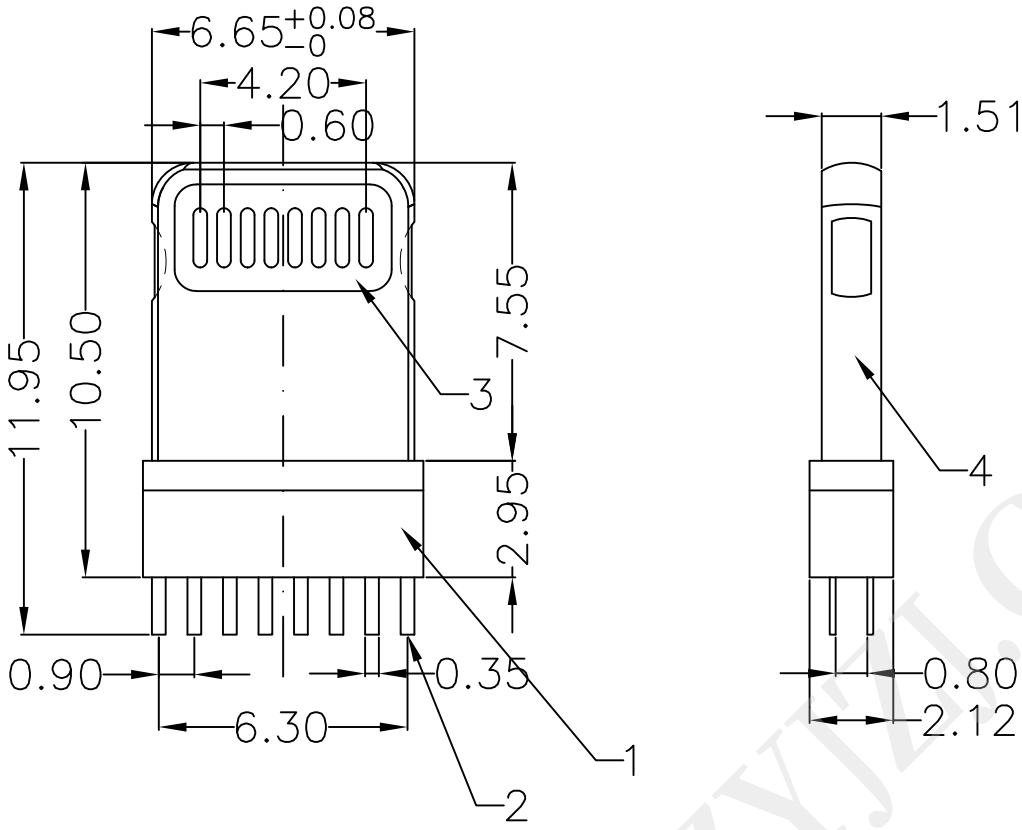
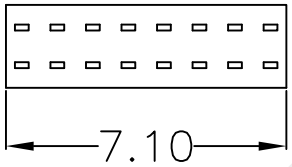




NOTES:

1. MATERIALS:

①:LCP（一次Molding).

②:C2680, T=0.15±0.02mm镀半金雾锡.

③:ABS苹果白（二次Molding).

④;锌合金

2. 有"*"标志的为重点尺寸.

深圳市华宇创精密电子有限公司				
TOLERANCE: X.X ±0.30, X.XX ±0.25, X.XXX ±0.15, X.° ±2°, X.X° ±0.5°	DRAWED BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 苹果公座8P 夹板0.8	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC30-IPOD08-080
			MOLD NO.	
UNIT: mm [inch]	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO:	HYC-2602280929
SCALE:1:1 SIZE: A4			SHEET NO.	1 OF 1

WWW.DZYJZJ.COM